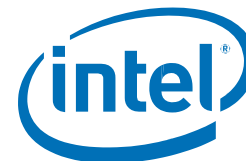




PRODUCT BRIEF
Intel® Dual Band Wireless-AC 7260
 802.11ac, Dual Band, 2x2 Wi-Fi + Bluetooth 4.0*



Intel® Dual Band Wireless-AC 7260



Ultra Wi-Fi. Ultra Features. Ultra Connected Experience

The Intel® Dual Band Wireless-AC 7260 802.11ac, dual band, 2x2 Wi-Fi + Bluetooth* adapter lets you move at the speed of life with faster speeds (up to 867 Mbps¹), higher capacity, broader coverage and longer battery life. Combined with 4th Gen Intel® Core™ processors and exceptional Intel wireless innovations, the Intel® Dual Band Wireless-AC 7260 dramatically reshapes your connected experience at home, work or on the go.

Next-Gen 802.11ac Wireless



More Speed
Better Coverage
Larger Capacity

Delivers dramatically faster Wi-Fi speeds (up to 867 Mbps¹) than 802.11n, with more bandwidth per stream (433 Mbps), more capacity for more users (extended channel bonding 80MHz), broader coverage and better battery life (more data transmit efficiencies reduce power consumption).

802.11ac, Dual Band, 80MHz, 2x2



Bluetooth 4.0* Smart Ready (Low Energy)

Dual mode Bluetooth 4.0* connects to the newest low energy Bluetooth* products as well as your familiar devices, such as headsets, keyboard, mice and more.



Intel® Power Optimizer²

Optimized power modes during periods of activity and inactivity to improve platform battery life for greater mobility and convenience. Dramatically lower power consumption than previous generation products.



HMC and M.2 Form Factors

Single sided HMC and M.2 modules support multiple connectors for flexible system configuration and platform usages. The new M.2 form factor (2230 and 2226 Solder Down) delivers a smaller, lower profile, more flexible form factor for thin-and-light designs.

Experience the Intel Difference



Your Ultrabook™ On Your TV
[Intel® Wireless Display³](#)

Watch your PC or Ultrabook™ content instantly without wires on the big HD screen with stunning image clarity and sound. Intel® Wireless Display gives you a serious entertainment upgrade. Stream movies, videos, games, photos, connect with friends, and more—experience it all, bigger and better than ever before.



Always Ready to Go
[Intel® Smart Connect Technology⁴](#)

Stay current with automatic, no-wait updates to your email and social networks, even when your device is asleep. Combine it with Intel® WiFi HotSpot Assistant and automatically connect to millions of free and paid hotspots to refresh your content in more locations worldwide.



Instant Internet Worldwide
[Intel® WiFi Hotspot Assistant⁵](#)

Delivers instant Internet connectivity at millions of free and paid hotspot worldwide. After accepting a one-time only terms and conditions (T&C) login, your Internet connections are on auto-pilot as you roam the Wi-Fi hotspot universe—even as your Ultrabook™ sleeps. Combine it with Intel® Smart Connect Technology and your favorite cloud content (email, social networks, news, etc.) is automatically refreshed as you roam.

Business-Class Wireless



Intel® vPro™ Technology⁶

Supports Intel's hardware-based security and management features built into Intel® Core™ vPro™ processors and chipsets that enables IT to manage PCs virtually anywhere, anytime while reducing deployment costs, improving security and ROI.



Intel® Active Management Technology⁷

Using integrated platform capabilities and popular third-party management and security applications, Intel® AMT allows IT or managed service providers to better discover, repair, and protect their networked computing assets. Intel® AMT is a feature of 3rd generation Intel® Core™ processors with Intel® vPro™ technology.



Intel® PROSet/Wireless Software⁸

Combines simplified user interface design with advanced IT tools to improve security, reduce complexity and save IT time and money. Streamlines client deployments and allows remote management of wireless settings and profiles by IT managers.



Intel Location Based Service⁹

Enables seamless Wi-Fi indoor location service capability for employees to see campus maps with reference to their location, locate the nearest resource (printer, conference, room, elevator, etc.), or for asset tracking.

Intel® Dual Band Wireless-AC 7260 Technical Specifications

General

Dimensions (H x W x D)	HMC: 26.80 mm x 30 mm x 2.4 mm Max (Top Side) / 1.35 mm Max (Bottom Side) Single Sided M.2 2230: 22 mm x 30 mm x 2.4 mm [1.5mm Max (Top Side)/ 0.1mm Max (Bottom Side)] M.2 2226: 22 mm x 26 mm x 2.4 mm [1.5mm Max (Top Side)/ 0.1mm Max (Bottom Side)]
Weight	HMC: 3.0g M.2 2230: 2.3g M.2 2226: 2.2g
Diversity	Supported
Radio ON/OFF Control	Supported in both hardware and software
Connector interface	HMC: PCIe, USB M.2: PCIe, USB
LED Output	On/Off
Operating Temperature (Adapter Shield)	0° to +80° C
Humidity Non-Operating	50% to 90% RH non-condensing (at temperatures of 25°C to 35°C)
Operating Systems	Microsoft Windows 7*, Microsoft Windows 8*, Linux* (most features not available on Linux)
Wi-Fi Alliance	Wi-Fi CERTIFIED* for 802.11ac, Wi-Fi CERTIFIED* a/b/g, Wi-Fi CERTIFIED* n, WMM*, WPA*, WPA2*, and WPS, WPS 2.0, Protected Management Frames, Wi-Fi Direct* for peer to peer device connections
IEEE WLAN Standard	IEEE 802.11abgn, 802.11ac, 802.11d, 802.11e, 802.11i, 802.11h, 802.11w
Architecture	Infrastructure and SoftAP; Supports simultaneous Client and SoftAP modes
Roaming ¹⁰	Supports seamless roaming between respective access points (802.11b, 802.11g, 802.11a/b/g, 802.11a/b/g/n, and 802.11ac)
Bluetooth*	Dual Mode Bluetooth* 2.1, 2.1+EDR, 3.0, 3.0+HS, 4.0 (BLE)

Security¹¹

Authentication	WPA and WPA2, 802.1X (EAP-TLS, TTLS, PEAP, LEAP, EAP-FAST), EAP-SIM, EAP-AKA
Authentication Protocols	PAP, CHAP, TLS, GTC, MS-CHAP*, MS-CHAPv2
Encryption	64-bit and 128-bit WEP, AES-CCMP, TKIP
Wi-Fi Direct* Encryption and Authentication	WPA2, AES-CCMP
Product Safety	UL, C-UL, CB (IEC 60950-1)
Management Frame Protection	802.11w (WFA- Protected Management Frames)

Compliance

Government	FIPS ¹² , FISMA
Retail (Credit Card Processing)	PCI, CISP

Product Name	Model Number	Version
Intel® Dual Band Wireless-AC 7260	7260HMW	802.11ac, 2x2, Bluetooth 4.0, PCIe, USB, HMC
	7260NGW	802.11ac, 2x2, Bluetooth 4.0, PCIe, USB, M.2 2230
	7260SDW	802.11ac, 2x2, Bluetooth 4.0, PCIe, USB, M.2 2226 Solder Down



For more information on Intel® Wireless products, visit intel.com/wireless

¹ Based on the theoretical maximum bandwidth enabled by 2x2 802.11ac implementations. Actual wireless throughput and/or range will vary depending on your specific operating system, hardware and software configurations. Check with your PC manufacturer for details.

² Actual platform battery life savings will vary depending on your specific operating system, hardware and software configurations. Check with your PC manufacturer for details.

³ Intel® Wireless Display requires an Intel® Wireless Display enabled PC, tablet, or smartphone, a compatible adapter, and a TV. 1080p and Blu-Ray* or other protected content playback only available on select Intel® processors with built-in visuals enabled. Consult your PC manufacturer. For more information, see www.intel.com/go/widi

⁴ Intel® Smart Connect Technology requires a select Intel® processor, Intel® software and BIOS update, Intel® Wireless adaptor, and Internet connectivity. Solid state memory or drive equivalent may be required. Depending on system configuration, your results may vary. Contact your system manufacturer for more information.

⁵ Intel WiFi Hotspot Assistant requires an Intel wireless adapter, Intel® PROSet/Wireless WiFi Software v15.6 or later, and an Internet connection for initial setup with the Easy WiFi* network.

⁶ Intel® vPro™ Technology is sophisticated and requires setup and activation. Availability of features and results will depend upon the setup and configuration of your hardware, software and IT environment. To learn more visit: <http://www.intel.com/technology/vpro>

⁷ Requires activation and a system with a corporate network connection, an Intel® AMT-enabled chipset, network hardware and software. For notebooks, Intel® AMT may be unavailable or limited over a host OS-based VPN, when connecting wirelessly, on battery power, sleeping, hibernating or powered off. Results dependent upon hardware, setup & configuration. For more information, visit <http://www.intel.com/technology/platform-technology/intel-amt>

⁸ Intel® PROSet/Wireless Software may not be supported by your PC manufacturer. Check with your PC manufacturer for details on availability.

⁹ Intel Location Based Service requires selected Intel wireless adapters and Intel® PROSet/Wireless WiFi Software v15.6 or later on Intel® 4th Gen Core processor-based PCs only.

¹⁰ Roaming is supported only within each respective band and mode of access points.

¹¹ Some security solutions may not be supported by your PC's operating system and/or by your PC manufacturer. Check with your PC manufacturer for details on availability.

¹² Microsoft Windows 7 and Microsoft Windows 8.

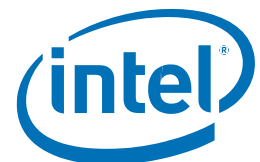
Software and workloads used in performance tests may have been optimized for performance only on Intel microprocessors. Performance tests, such as SYSmark and MobileMark, are measured using specific computer systems, components, software, operations and functions. Any change to any of those factors may cause the results to vary. You should consult other information and performance tests to assist you in fully evaluating your contemplated purchases, including the performance of that product when combined with other products.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document. Except as provided in Intel's Terms and Conditions of Sale for such products, Intel assumes no liability whatsoever, and Intel disclaims any express or implied warranty, relating to sale and/or use of Intel products including without limitation, liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright or other intellectual property right. Intel products are not intended for use in medical, lifesaving, or life sustaining applications. Intel may make changes to specifications and product descriptions at any time, without notice. For the most current product information, please visit: <http://www.intel.com/wireless>

Intel, the Intel logo, Intel, and Intel Centrino are trademarks or registered trademarks of Intel Corporation or its subsidiaries in the United States and other countries.

*Other names and brands may be claimed as the property of others

Copyright © 2014 Intel Corporation. All rights reserved.



Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[Intel:](#)

[7260.HMWVB](#) [7260.NGIG](#) [7260.NGWGC.S](#) [7260.NGWG.NV](#) [7260.NGWG.S](#) [7260.HMWD](#) [7260.HMWG.NV](#)
[7260.NGWGU.NV](#) [7260.HMWG.S](#) [7260.HMID](#) [7260.HMIGC](#) [7260.HMWGC](#) [7260.NGWGUX](#) [7260.NGWGP](#)
[7260.NGWD.S](#) [7260.NGWGC](#) [7260.NGID](#) [7260.HMWGUX](#) [7260.HMWGU](#) [7260.NGIGC](#) [7260.NGWG](#)



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

Телефон: 8 (812) 309 58 32 (многоканальный)

Факс: 8 (812) 320-02-42

Электронная почта: org@eplast1.ru

Адрес: 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.